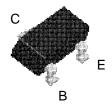


### FSB660 / FSB660A



SuperSOT<sup>™</sup>-3 (SOT-23)

# **PNP Low Saturation Transistor**

These devices are designed with high current gain and low saturation voltage with collector currents up to 2A continuous.

## Absolute Maximum Ratings\* T<sub>A = 25°C unless otherwise noted</sub>

| Symbol                                | Parameter  | FSB660/FSB660A | Units |
|---------------------------------------|--|----------------|-------|
| V <sub>CEO</sub>                      | Collector-Emitter Voltage                        | 60             | V     |
| V <sub>CBO</sub>                      | Collector-Base Voltage                           | 60             | V     |
| V <sub>EBO</sub> Emitter-Base Voltage |  | 5              | V     |
| Ic                                    | Collector Current - Continuous                   | 2              | Α     |
| T <sub>J</sub> , T <sub>stg</sub>     | Operating and Storage Junction Temperature Range | -55 to +150    | °C    |

<sup>\*</sup>These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

#### NOTES:

- 1) These ratings are based on a maximum junction temperature of 150°C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Thermal Characteristics T<sub>A = 25°C unless otherwise noted</sub>

| Symbol           | Characteristic                          | Max            | Units |
|------------------|---|----------------|-------|
|                  |   | FSB660/FSB660A |       |
| P <sub>D</sub>   | Total Device Dissipation                | 500            | mW    |
| R <sub>θJA</sub> | Thermal Resistance, Junction to Ambient | 250            | °C/W  |

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| PNP | Low | Saturation   | <b>Transistor</b> |
|-----|-----|--------------|-------------------|
|     |     | Oatal alloll | HIGHSISTON        |

(continued)

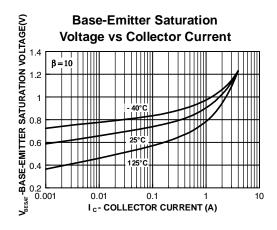
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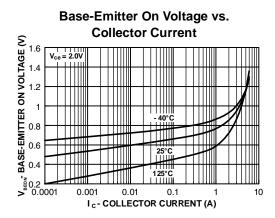
 $T_{A=25^{\circ}\text{C}}$  unless otherwise noted

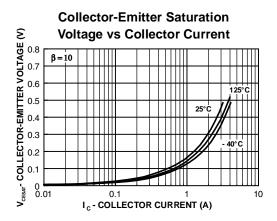
| Symbol               | Parameter                            | Test Conditions  | Min | Max  | Units |
|----------------------|--------------------------------------|--|-----|------|-------|
| OFF CHAI             | RACTERISTICS                         |  |     |      |       |
| BV <sub>CEO</sub>    | Collector-Emitter Breakdown Voltage  | I <sub>C</sub> = 10 mA                                     | 60  |      | V     |
| BV <sub>CBO</sub>    | Collector-Base Breakdown Voltage     | I <sub>C</sub> = 100 μA                                    | 60  |      | V     |
| BV <sub>EBO</sub>    | Emitter-Base Breakdown Voltage       | I <sub>E</sub> = 100 μA                                    | 5   |      | V     |
| I <sub>CBO</sub>     | Collector Cutoff Current             | V <sub>CB</sub> = 30 V                                     |     | 100  | nA    |
|                      |                                      | V <sub>CB</sub> = 30 V, T <sub>A</sub> =100°C              |     | 10   | uA    |
| I <sub>EBO</sub>     | Emitter Cutoff Current               | V <sub>EB</sub> = 4V                                       |     | 100  | nA    |
| ON CHAR              | ACTERISTICS*                         |  |     |      |       |
| h <sub>FE</sub>      | DC Current Gain                      | I <sub>C</sub> = 100 mA, V <sub>CE</sub> = 2 V             | 70  |      | -     |
|                      |                                      | I <sub>C</sub> =500mA, V <sub>CE</sub> =2V <b>FSB660</b>   | 100 | 300  |       |
|                      |                                      | FSB660A  | 250 | 550  |       |
|                      |                                      | I <sub>C</sub> = 1 A, V <sub>CE</sub> = 2 V                | 80  |      |       |
|                      |                                      | $I_C = 2 A$ , $V_{CE} = 2 V$                               | 40  |      |       |
| V <sub>CE(sat)</sub> | Collector-Emitter Saturation Voltage | I <sub>C</sub> = 1 A, I <sub>B</sub> = 100 mA              |     | 300  | mV    |
| , ,                  |                                      | I <sub>C</sub> = 2 A, I <sub>B</sub> =200 mA <b>FSB660</b> |     | 350  |       |
|                      |                                      | FSB660A  |     | 300  |       |
| V <sub>BE(sat)</sub> | Base-Emitter Saturation Voltage      | I <sub>C</sub> = 1 A, I <sub>B</sub> = 100 mA              |     | 1.25 | V     |
| V <sub>BE(on)</sub>  | Base-Emitter On Voltage              | I <sub>C</sub> = 1 A, V <sub>CE</sub> = 2 V                |     | 1    | V     |
| SMALL SI             | GNAL CHARACTERISTICS                 |  |     |      |       |
| C <sub>obo</sub>     | Output Capacitance                   | V <sub>CB</sub> = 10 V, I <sub>E</sub> = 0, f = 1MHz       |     | 30   | pF    |
| f <sub>T</sub>       | Transition Frequency                 | I <sub>C</sub> = 100 mA,V <sub>CE</sub> = 5 V, f=100MHz    | 75  |      | -     |
|                      | I.                                   | 1  |     | 1    |       |

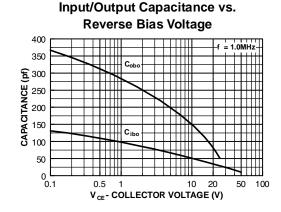
\*Pulse Test: Pulse Width  $\leq 300~\mu s,~Duty~Cycle \leq 2.0\%$ 

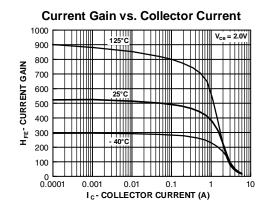
## **Typical Characteristics**











FSB660/FSB660A Rev. B1

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| CROSSVOLT™           | GlobalOptoisolator™ | Power247™           | SuperSOT™-6     |
| DenseTrench™         | GTO™                | PowerTrench®        | SuperSOT™-8     |
| DOME™                | HiSeC™              | QFET™               | SyncFET™        |
| EcoSPARK™            | ISOPLANAR™          | QS™                 | TinyLogic™      |
| E <sup>2</sup> CMOS™ | LittleFET™          | QT Optoelectronics™ | TruTranslation™ |
| EnSigna™             | MicroFET™           | Quiet Series™       | UHC™            |
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|--------------------------|---------------------------|---|
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